

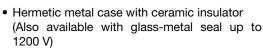
Phase Control Thyristors (Stud Version), 200 A



PRODUCT SUMMARY			
I _{T(AV)}	200 A		
V _{DRM} /V _{RRM}	400 V, 800 V, 1200 V, 1600 V, 2000 V		
V _{TM}	1.75 V		
I _{GT}	150 mA		
T _J	-40 °C to 125 °C		
Package	TO-209AB (TO-93)		
Diode variation	Single SCR		

FEATURES

- Center amplifying gate
- International standard case TO-209AB (TO-93)





- Compression bonded encapsulation for heavy duty operations such as severe thermal cycling
- · Designed and qualified for industrial level
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

- DC motor controls
- Controlled DC power supplies
- AC controllers

MAJOR RATINGS AND CHARACTERISTICS					
PARAMETER	TEST CONDITIONS	VALUES	UNITS		
1		200	A		
I _{T(AV)}	T _C	85	°C		
I _{T(RMS)}		314	Α		
1	50 Hz	5000	A		
I _{TSM}	60 Hz	5230	A		
l ² t	50 Hz	125	kA ² s		
1-1	60 Hz	114	KA-S		
V _{DRM} /V _{RRM}		400 to 2000	V		
t _q	Typical	100	μs		
T _J		-40 to 125	°C		

ELECTRICAL SPECIFICATIONS

VOLTAGE RATINGS							
TYPE NUMBER	VOLTAGE CODE	V _{DRM} /V _{RRM} , MAXIMUM REPETITIVE PEAK AND OFF-STATE VOLTAGE	V _{RSM} , MAXIMUM NON-REPETITIVE PEAK VOLTAGE	I_{DRM}/I_{RRM} MAXIMUM AT $T_J = T_J$ MAXIMUM			
		V	V	mA			
	04	400	500				
	08	800	900				
VS-ST180S	12	1200	1300	30			
	16	1600	1700				
	20	2000	2100				



ABSOLUTE MAXIMUM RATINGS	3					
PARAMETER	SYMBOL		TEST CONDITIONS			UNITS
Maximum average on-state current	I _{T(AV)}	180° condu	ction, half sine	NSVA	200	Α
at case temperature	T(AV)	100 condu	Ction, nan sinc	wavc	85	°C
Maximum RMS on-state current	I _{T(RMS)}	DC at 76 °C	case temperat	ure	314	
		t = 10 ms	No voltage		5000	
Maximum peak, one-cycle		t = 8.3 ms	reapplied		5230	A kA ² s
non-repetitive surge current	I _{TSM}	t = 10 ms	100 % V _{RRM}		4200	
		t = 8.3 ms	reapplied	Sinusoidal half wave,	4400	
		t = 10 ms	No voltage reapplied	initial T _J = T _J maximum	125	
Marrian III fan frain	l ² t	t = 8.3 ms			114	
Maximum I ² t for fusing		t = 10 ms	100 % V _{RRM}		88	
		t = 8.3 ms	reapplied		81	
Maximum l²√t for fusing	I ² √t	t = 0.1 to 10	ms, no voltage	reapplied	1250	kA²√s
Low level value of threshold voltage	V _{T(TO)1}	(16.7 % x π	$x I_{T(AV)} < I < \pi x$	$I_{T(AV)}$), $T_J = T_J$ maximum	1.08	V
High level value of threshold voltage	V _{T(TO)2}	$(I > \pi \times I_{T(AV)})$	$(I > \pi \times I_{T(AV)}), T_J = T_J \text{ maximum}$		1.14	V
Low level value of on-state slope resistance	r _{t1}	$(16.7 \% \times \pi \times I_{T(AV)} < I < \pi \times I_{T(AV)}), T_J = T_J \text{ maximum}$		1.18		
High level value of on-state slope resistance	r _{t2}	$(I > \pi \times I_{T(AV)}), T_J = T_J \text{ maximum}$		1.14	mΩ	
Maximum on-state voltage	V_{TM}	$I_{pk} = 570 \text{ A}, T_J = 125 \text{ °C}, t_p = 10 \text{ ms sine pulse}$			1.75	V
Maximum holding current	I _H	T T			600	A
Maximum (typical) latching current	ΙL	$T_J = T_J$ maximum, anode supply 12 V resistive load 1000 (30			1000 (300)	- mA

SWITCHING						
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS		
Maximum non-repetitive rate of rise of turned-on current	dl/dt	Gate drive 20 V, 20 Ω , $t_r \le 1~\mu s$ $T_J = T_J$ maximum, anode voltage $\le 80~\%~V_{DRM}$	1000	A/µs		
Typical delay time	t _d	Gate current 1 A, $dl_g/dt = 1 A/\mu s$ $V_d = 0.67 \% V_{DRM}, T_J = 25 °C$	1.0			
Typical turn-off time	t _q	$\begin{split} I_{TM} = 300 \text{ A, } T_J = T_J \text{ maximum, dl/dt} = 20 \text{ A/}\mu\text{s,} \\ V_R = 50 \text{ V, dV/dt} = 20 \text{ V/}\mu\text{s, gate 0 V 100 }\Omega, t_p = 500 \mu\text{s} \end{split}$	100	μs		

BLOCKING					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum critical rate of rise of off-state voltage	dV/dt	$T_J = T_J$ maximum linear to 80 % rated V_{DRM}	500	V/µs	
Maximum peak reverse and off-state leakage current	I _{RRM} , I _{DRM}	$T_J = T_J$ maximum, rated V_{DRM}/V_{RRM} applied	30	mA	



TRIGGERING							
PARAMETER	SYMBOL	_	TEST CONDITIONS		VALUES		
PARAMETER	STINIBUL	'			MAX.	UNITS	
Maximum peak gate power	P _{GM}	$T_J = T_J$ maximum,	$t_p \le 5 \text{ ms}$	1	0	W	
Maximum average gate power	P _{G(AV)}	$T_J = T_J$ maximum,	f = 50 Hz, d% = 50	2	.0	VV	
Maximum peak positive gate current	I _{GM}	$T_J = T_J$ maximum,	$t_p \le 5 \text{ ms}$	3	.0	Α	
Maximum peak positive gate voltage	+ V _{GM}	T T in 1		20		0	V
Maximum peak negative gate voltage	- V _{GM}	ij = ijiliaxililulli,	$T_J = T_J$ maximum, $t_p \le 5$ ms		5.0		
	I _{GT}	T _J = - 40 °C	Maximum required gate trigger/ current/voltage are the lowest	180	-	mA	
DC gate current required to trigger		T _J = 25 °C		90	150		
		T _J = 125 °C		40	-		
		T _J = - 40 °C	value which will trigger all units 12 V anode to cathode applied	2.9	-		
DC gate voltage required to trigger	V_{GT}	T _J = 25 °C	12 v anode to cathode applied	1.8	3.0	V	
		T _J = 125 °C		1.2	-		
DC gate current not to trigger	I _{GD}		Maximum gate current/voltage	10		mA	
DC gate voltage not to trigger	V_{GD}	$T_J = T_J \text{ maximum}$	not to trigger is the maximum value which will not trigger any unit with rated V _{DRM} anode to cathode applied	0.:	25	V	

THERMAL AND MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS		
Maximum operating junction temperature range	TJ		-40 to 125	°C		
Maximum storage temperature range	T _{Stg}		-40 to 150			
Maximum thermal resistance, junction to case	R _{thJC}	DC operation	0.105	K/W		
Maximum thermal resistance, case to heatsink	R _{thC-hs}	Mounting surface, smooth, flat and greased 0				
Mounting torque + 10.0/		Non-lubricated threads	31 (275)	N·m		
Mounting torque, ± 10 %		Lubricated threads	24.5 (210)	(lbf · in)		
Approximate weight			280	g		
Case style		See dimensions - link at the end of datasheeet	TO-209AB (T	O-93)		

△R _{thJC} CONDUCTION						
CONDUCTION ANGLE	SINUSOIDAL CONDUCTION	RECTANGULAR CONDUCTION	TEST CONDITIONS	UNITS		
180°	0.015	0.012				
120°	0.019	0.020				
90°	0.025	0.027	$T_J = T_J$ maximum	K/W		
60°	0.036	0.037				
30°	0.060	0.060				

Note

The table above shows the increment of thermal resistance R_{thJC} when devices operate at different conduction angles than DC

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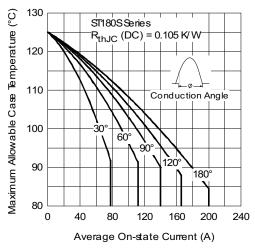


Fig. 1 - Current Ratings Characteristics

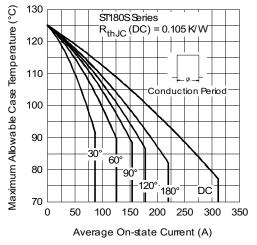


Fig. 2 - Current Ratings Characteristics

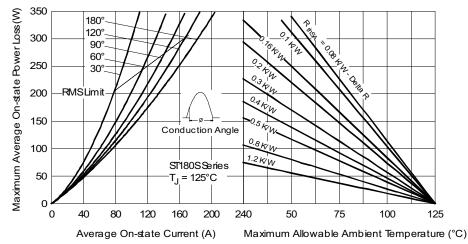


Fig. 3 - On-State Power Loss Characteristics

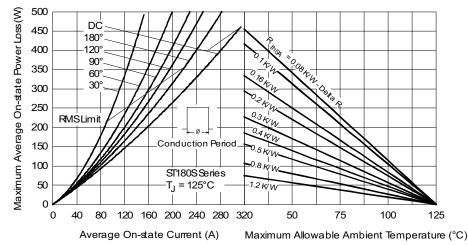


Fig. 4 - On-State Power Loss Characteristics

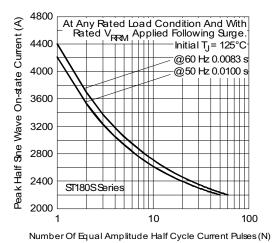


Fig. 5 - Maximum Non-Repetitive Surge Current

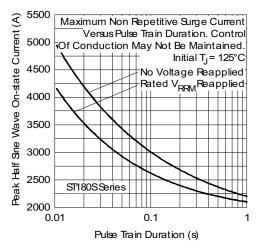


Fig. 6 - Maximum Non-Repetitive Surge Current

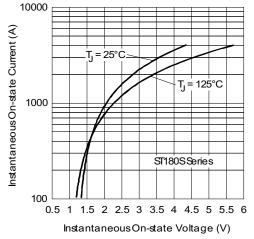


Fig. 7 - On-State Voltage Drop Characteristics

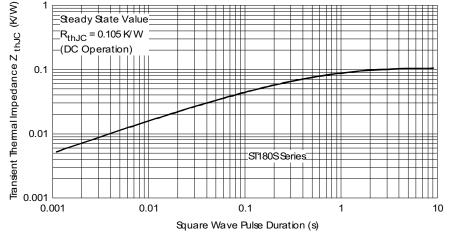


Fig. 8 - Thermal Impedance Z_{thJC} Characteristics

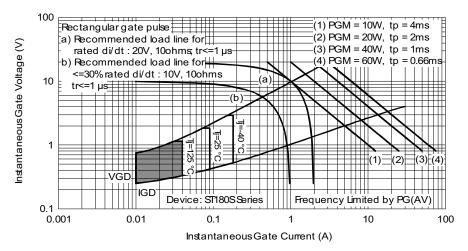
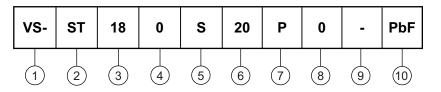


Fig. 9 - Gate Characteristics

ORDERING INFORMATION TABLE

Device code



1 - Vishay Semiconductors product

2 - Thyristor

Essential part number

4 - 0 = Converter grade

5 - S = Compression bonding stud

6 - Voltage code x 100 = V_{RRM} (see Voltage Ratings table)

| 7 | - P = Stud base 3/4"-16UNF2A threads

8 - 0 = Eyelet terminals (gate and auxiliary cathode leads)

1 = Fast-on terminals (gate and auxiliary cathode leads)

9 - V = Glass-metal seal (only up to 1200 V)

None = Ceramic housing (over 1200 V)

- None = Standard production

- PbF = Lead (Pb)-free

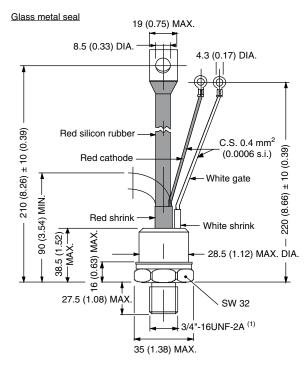
Note: For metric device M16 x 1.5 contact factory

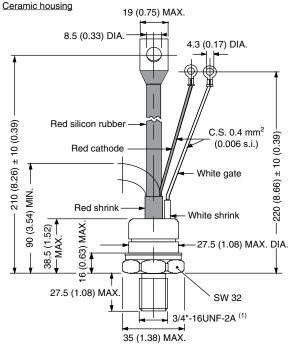
LINKS TO RELAT	TED DOCUMENTS
Dimensions	www.vishay.com/doc?95082

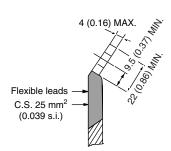


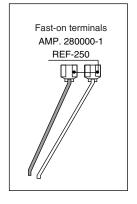
TO-209AB (TO-93)

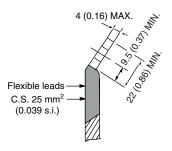
DIMENSIONS in millimeters (inches)











Note

(1) For metric device: M16 x 1.5 - length 21 (0.83) maximum



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